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May 2000 Revised December 2005

FSA266 • NC7WB66 Low Voltage Dual SPST

Normally Open Analog Switch or 2-Bit Bus Switch

General Description

The FSA266 or NC7WB66 is an ultra high-speed (UHS) dual single-pole/single-throw (SPST) analog switch or 2-bit bus switch. The device is fabricated with advanced sub-micron CMOS technology to achieve high speed enable and disable times and low On Resistance over a broad $\rm V_{CC}$ range. The device is specified to operate over the 1.65 to 5.5V $\rm V_{CC}$ operating range. The device is organized as a dual switch with independent CMOS compatible switch enable (OE) controls. When OE is HIGH, the switch is ON and Port A is connected to Port B. When OE is LOW, the switch is OPEN and a high-impedance state exists between the two ports. The enable inputs tolerate voltages up to 5.5V independent of the $\rm V_{CC}$ operating range.

Features

- Useful in both analog and digital applications
- Space saving US8 surface mount package
- MicroPak™ Pb-Free leadless package
- Typical 7Ω On Resistance @ 5V V_{CC}
- Broad V_{CC} operating range: 1.65V to 5.5V
- Rail-to-Rail signal handling
- Power down high impedance control inputs
- Control inputs are overvoltage tolerant
- Control inputs are CMOS compatible
- >300 MHz -3dB bandwidth

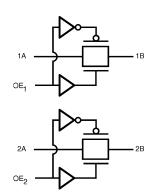
Ordering Code:

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
FSA266K8X	MAB08A	WB66	8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide	3K Units on Tape and Reel
FSA266L8X	MAC08A	P4	Pb-Free 8-Lead MicroPak, 1.6 mm Wide	5K Units on Tape and Reel
NC7WB66K8X	MAB08A	WB66	8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide	3K Units on Tape and Reel
NC7WB66L8X	MAC08A	P4	Pb-Free 8-Lead MicroPak, 1.6 mm Wide	5K Units on Tape and Reel

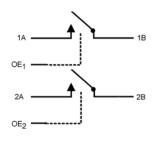
Pb-Free package per JEDEC J-STD-020B.

 $\label{eq:microPak} \mbox{MicroPak}^{\tiny{\text{TM}}} \mbox{ is a trademark of Fairchild Semiconductor Corporation.}$

Logic Symbol



Analog Symbol



Pin Descriptions

Pin Names	Description
A	Switch Port A
В	Switch Port B
OE	Control Input

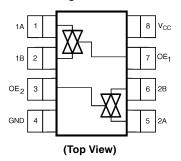
Function Table

Switch Enable Input (OE)	Function
L	Disconnect
Н	B Connected to A

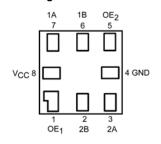
H = HIGH Logic Level L = LOW Logic Level

Connection Diagrams

Pin Assignments for US8



Pad Assignments for MicroPak



(Top Through View)

Absolute Maximum Ratings(Note 1)

 $\begin{array}{lll} \text{Supply Voltage (V}_{CC}) & -0.5 \text{V to } +7.0 \text{V} \\ \text{DC Switch Voltage (V}_{S}) & -0.5 \text{V to V}_{CC} + 0.5 \text{V} \\ \text{DC Input Voltage (V}_{IN}) \text{ (Note 2)} & -0.5 \text{V to } +7.0 \text{V} \\ \text{DC Input Diode Current} \end{array}$

Junction Lead Temperature

under Bias (T_J) +150°C

Junction Lead Temperature (T_L)

(Soldering, 10 Seconds) +260°C

Power Dissipation (P_D) @ +85°C

SC70-6 250 mW

Recommended Operating Conditions (Note 3)

Input Rise and Fall Time (t_r, t_f)

Control Input $V_{CC} = 1.65V - 2.7V$ 0 ns/V to 20 ns/V Control Input $V_{CC} = 3.0V - 3.6V$ 0 ns/V to 10 ns/V Control Input $V_{CC} = 4.5V - 5.5V$ 0 ns/V to 5 ns/V Thermal Resistance (θ_{1A}) 250°C/W

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

Note 3: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	V _{CC}	T _A = +25°C		T _A = -40°C to +85°C		Units	Conditions	
Symbol	raiametei	(V)	Min	Тур	Max	Min	Max	Ullits	Conditions
V _{IH}	HIGH Level Input Voltage	1.65 to 1.95	0.75 V _{CC}			0.75 V _{CC}		V	
		2.3 to 5.5	0.7 V _{CC}			0.7 V _{CC}		v	
V _{IL}	LOW Level Input Voltage	1.65 to 1.95			0.25 V _{CC}		0.25V _{CC}	V	
		2.3 to 5.5			0.3 V _{CC}		0.3 V _{CC}	l v	
I _{IN}	Input Leakage Current	0 to 5.5			±0.1		±1.0	μΑ	$0 \leq V_{IN} \leq 5.5V$
l _{OFF}	Switch OFF Leakage Current	1.65 to 5.5			±0.1		±1.0	μΑ	$0 \le A, B \le V_{CC}$
R _{ON}	Switch On Resistance			6.0	10.0		10.0		$V_1 = 0V, I_0 = 30 \text{ mA}$
	(Note 4)	4.5		7.0	13.5		13.5	Ω	$V_1 = 2.4V, I_0 = -30 \text{ mA}$
				6.0	10.0		10.0		$V_1 = 4.5V, I_0 = -30 \text{ mA}$
		3.0		7.5	15.0		15.0	Ω	V _I = 0V, I _O = 24 mA
		3.0		8.5	15.0		15.0	\$2	$V_1 = 3V, I_0 = -24 \text{ mA}$
		2.3		9.0	20.0		20.0	Ω	$V_{I} = 0V, I_{O} = 8 \text{ mA}$
	2.3		10.5	20.0		20.0	5.2	$V_1 = 2.3V, I_0 = -8 \text{ mA}$	
		1.65		12.5	30.0		30.0	Ω	$V_I = 0V$, $I_O = 4 \text{ mA}$
				17.0	30.0		30.0	5.2	$V_I = 1.65V, I_O = -4 \text{ mA}$
I _{cc}	Quiescent Supply Current	5.5			1.0		10.0	μА	V _{IN} = V _{CC} or GND
	All Channels ON or OFF	5.5			1.0		10.0	μΑ	I _{OUT} = 0
	Analog Signal Range	V _{CC}	0		V _{CC}	0	V _{CC}	V	
RRange	On Resistance Over	4.5		8.0	15.0		15.0		$I_O = -30 \text{ mA}, 0 \le V_I \le V_{CC}$
	Signal Range	3.0		15.0	30.0		30.0	Ω	$I_O = -24 \text{ mA}, \ 0 \le V_I \le V_{CC}$
	(Note 4)(Note 5)	2.3		45.0	75.0		75.0	52	$I_O = -8 \text{ mA}, \ 0 \le V_I \le V_{CC}$
		1.65		150	275		275		$I_O = -4 \text{ mA}, \ 0 \le V_I \le V_{CC}$
∆R _{ON}	On Resistance Match	4.5		0.2					I _O = -30 mA, V _I = 3.15
	Between Channels	3.0		0.2				Ω	$I_0 = -24 \text{ mA}, V_1 = 2.1$
	(Note 4)(Note 7)	2.3		0.5				52	$I_0 = -8 \text{ mA}, V_1 = 1.6$
		1.65		0.6					$I_0 = -4 \text{ mA}, V_1 = 1.15$
R _{flat}	On Resistance Flatness	4.5		2.5	6.0		6.0		$I_O = -30 \text{ mA}, 0 \le V_I \le V_{CC}$
	(Note 4)(Note 5)(Note 6)	3.0		8.0	17.5		17.5		$I_O = -24 \text{ mA}, 0 \le V_I \le V_{CC}$
		2.3		33.0	60.0		60.0		$I_O = -8 \text{ mA}, \ 0 \le V_I \le V_{CC}$
		1.65		135	250		250		$I_O = -4 \text{ mA}, \ 0 \le V_I \le V_{CC}$

Note 4: Measured by the voltage drop between A and B pins at the indicated current through the switch. On Resistance is determined by the lower of the voltages on the two (A or B) pins.

Note 5: Guaranteed by design.

Note 6: Flatness is defined as the difference between the minimum and maximum value of ON Resistance over the specified range of conditions.

DC Electrical Characteristics (Continued)

Note 7: $\Delta R_{ON} = R_{ON} \text{ max} - R_{ON} \text{ min measured at identical V}_{CC}$, temperature and voltage levels.

AC Electrical Characteristics

Symbol	Parameter	V _{CC}	TA	= -40°C to +8	5°C	Units	Conditions	Figure	
Syllibol	Farameter	(V)	Min	Тур	Max	Ullis	Conditions	Number	
t _{PHL} , t _{PLH}	Propagation Delay Bus-to-Bus	4.5 to 5.5		0.35	1.0				
	(Note 8)	3.0 to 3.6		0.7	1.5	ns	$V_I = OPEN$	Figures	
		2.3 to 2.7		1.1	2.5	115	$C_L = 50$ pF, $RU = RD = 500\Omega$	1, 2	
		1.65 to 1.95		2.0	4.0	1			
t_{PZL}, t_{PZH}	Output Enable Time	4.5 to 5.5	0.8	2.0	3.2				
	Turn on Time	3.0 to 3.6	1.2	2.5	3.9	ns	$V_I = 0V$ for t_{PZH}	Figures	
		2.3 to 2.7	1.5	3.2	5.6	1115	$V_I = 2 \times V_{CC}$ for t_{PZL}	1, 2	
		1.65 to 1.95	2.5	5.7	10.0		$C_L = 50$ pF, $RU = RD = 500\Omega$		
t _{PLZ} , t _{PHZ}	Output Disable Time	4.5 to 5.5	0.8	2.6	4.1			Figures 1, 2	
	Turn Off Time 3.	3.0 to 3.6	1.5	3.4	5.0	ns	$V_I = 0V$ for t_{PHZ}		
		2.3 to 2.7	2.0	4.2	6.9		$V_I = 2 \times V_{CC}$ for t_{PLZ}		
		1.65 to 1.95	3.0	6.2	10.5		$C_L = 50$ pF, $RU = RD = 500\Omega$		
Q	Charge Injection (Note 9)	1.65 to 5.5				рC	$C_L = 0.1 \text{ nF, } V_{GEN} = 0V,$	Figure 3	
							$R_{GEN} = 0 \Omega$, $f = 1 MHz$		
OIRR	Off Isolation (Note 10)	1.65 to 5.5		-55.0		dB	$R_L = 50 \Omega$, $C_L = 5 pF$,	Figure 4	
							f = 10 MHz		
Xtalk	Crosstalk	1.65 to 5.5		-70.0		dB	$R_L = 50 \ \Omega, \ C_L = 5 \ pF,$	Figure 5	
							f = 10 MHz		
BW	-3dB Bandwidth	1.65 to 5.5		>300		MHz	$R_L = 50 \Omega$	Figure 8	
THD	Total Harmonic Distortion						$R_L = 600\Omega$		
	(Note 9)	5		.016		%	0.5 V _{P-P}		
							f = 600 Hz to 20 KHz		

Note 8: This parameter is guaranteed by design. The switch contributes no propagation delay other than the RC delay of the On Resistance of the switch and the 50 pF load capacitance.

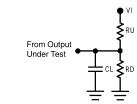
Note 9: Guaranteed by design.

Note 10: Off Isolation = $20 \log_{10} [V_A/V_{Bn}]$

Capacitance

Symbol	Parameter	Тур	Max	Units	Conditions	Figures
C _{IN}	Control Pin Input Capacitance	2.5		pF	V _{CC} = 0V	
C _{I/O} (OFF)	Switch Port Off Capacitance	5.0		pF	V _{CC} = 5.0V	Figure 6
C _{I/O} (ON)	Switch Port Capacitance when Switch is Enabled	10.0		pF	V _{CC} = 5.0V	Figure 7

AC Loading and Waveforms



Input driven by 50Ω source terminated in 50Ω

C_L includes load and stray capacitance.

Input PRR = 1.0 MHz; $t_w = 500 \text{ ns}$

FIGURE 1. AC Test Circuit

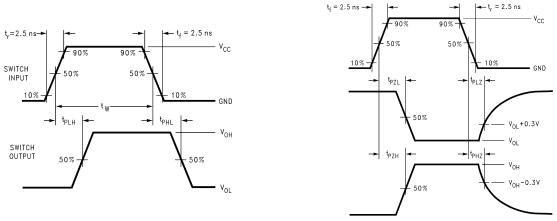


FIGURE 2. AC Waveforms

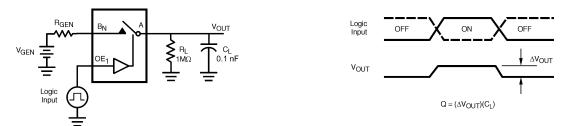


FIGURE 3. Charge Injection Test

AC Loading and Waveforms (Continued)

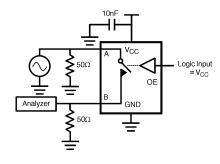


FIGURE 4. Off Isolation

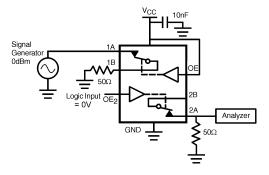


FIGURE 5. Crosstalk

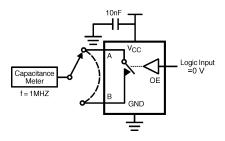


FIGURE 6. Channel Off Capacitance

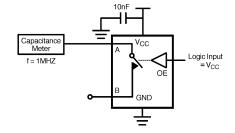


FIGURE 7. Channel On Capacitance

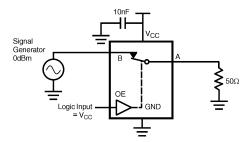


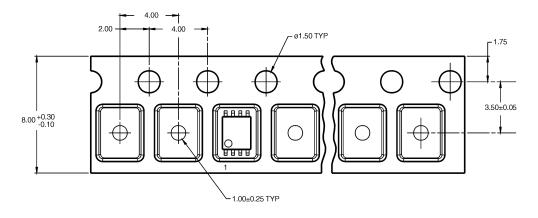
FIGURE 8. Bandwidth

Tape and Reel Specification

TAPE FORMAT for US8

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
	Leader (Start End)	125 (typ)	Empty	Sealed
K8X	Carrier	250	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

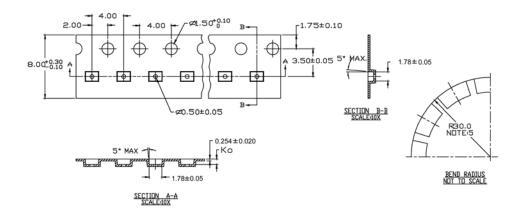
TAPE DIMENSIONS inches (millimeters)



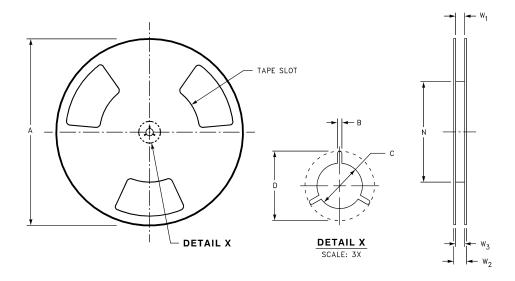
TAPE FORMAT for MicroPak

Package	Package Tape		Cavity	Cover Tape
Designator	Section	Cavities	Status	Status
	Leader (Start End)	125 (typ)	Empty	Sealed
L8X	Carrier	250	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

TAPE DIMENSIONS inches (millimeters)

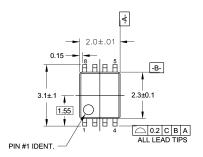


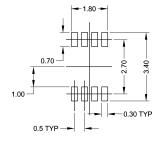
REEL DIMENSIONS inches (millimeters)



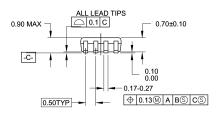
Tape Size	Α	В	С	D	N	W1	W2	W3
9 mm	7.0	0.059	0.512	0.795	2.165	0.331 + 0.059/-0.000	0.567	W1 + 0.078/-0.039
8 mm	(177.8)	(1.50)	(13.00)	(20.20)	(55.00)	(8.40 + 1.50/-0.00)	(14.40)	(W1 + 2.00/-1.00)

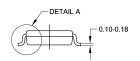
Physical Dimensions inches (millimeters) unless otherwise noted

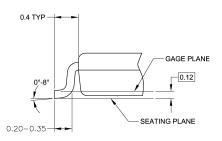




LAND PATTERN RECOMMENDATION







NOTES:

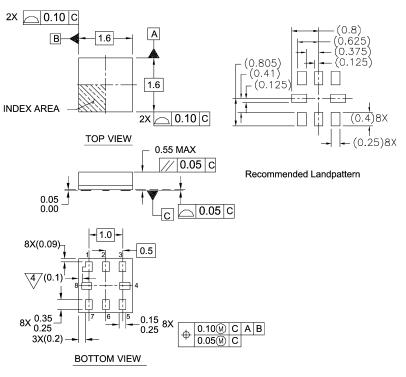
- A. CONFORMS TO JEDEC REGISTRATION MO-187 B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

DETAIL A

MAB08AREVC

8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide Package Number MAB08A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Notes:

- 1. PACKAGE CONFORMS TO JEDEC MO-255 VARIATION UAAD
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y.14M-1994
- 4/PIN 1 FLAG, END OF PACKAGE OFFSET.

MAC08AREVC

Pb-Free 8-Lead MicroPak, 1.6 mm Wide Package Number MAC08A

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provided in the labeling, can be reasonably expected to result in significant injury to the user.

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Datasheet Identification	Product Status	Definition
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